

# IEEE 2023 OA 投稿優惠詳解與操作流程

# 背景

IEEE為本輪訂購IEL資料庫的CONCERT成員學校在IEEE完全OA期刊\*發表論文提供優惠：

- 1) 學校**通訊作者**在**IEEE完全OA期刊**發表論文自動向機構申請使用APC Token支付
- 2) 通訊作者投稿過程中，通過**機構郵箱**或**機構資訊**進行匹配
- 3) 作者可以以**均一優惠價格USD1,560\*\***使用APC Token進行支付
- 4) 此優惠與其他優惠不可同時使用
- 5) Token使用申請將提交至機構管理員進行審核批復
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ORDER	ACTIONS	AUTHOR	INSTITUTION
1	Select...	He, Dandan (Corresponding Author) <b>dan.he@vip.163.com</b>	1. IEEE, CSM Room 1503, South Tower, Raycom InfoTech Park C, No.2 Kexueyuan South Road, Haidian District New York, CN 10016

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\* First (Given) Name: Dandan

Middle Name:

\* Last (Family) Name: He

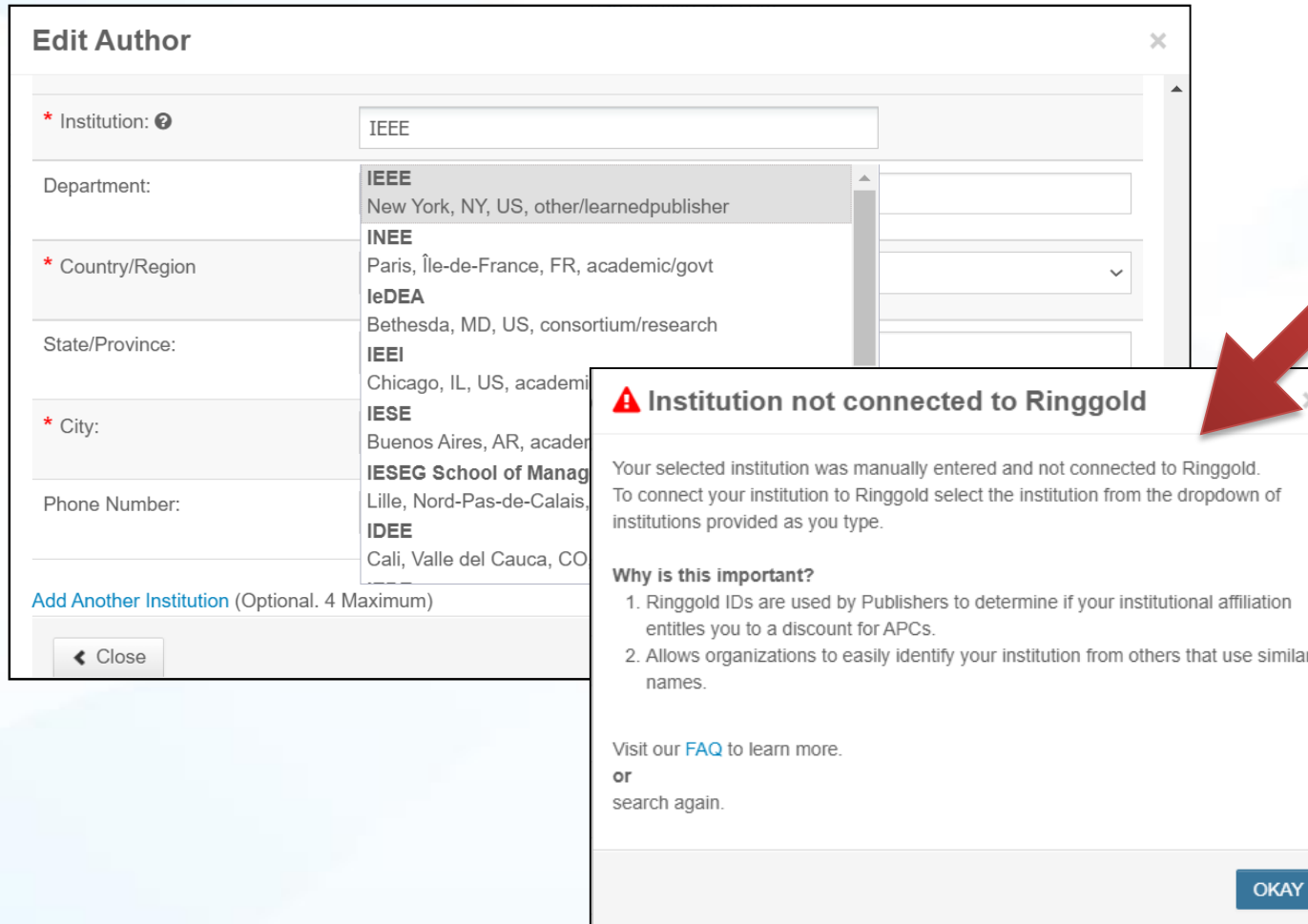
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點擊go to your profile, 編輯郵箱, 請注意使用**機構郵箱**;  
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- 1 Awaiting Final Files**
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- Accept (11-Jul-2017)

[Graphics Checker](#)

- Accept for Final Submission

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## Evaluation of Thermal Imaging on Embedded GPU Platforms for Application in Vehicular Assistance Systems

Publisher: IEEE

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# 3.eCF - 步驟 1

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# 3.eCF - 步驟 5

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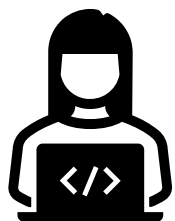
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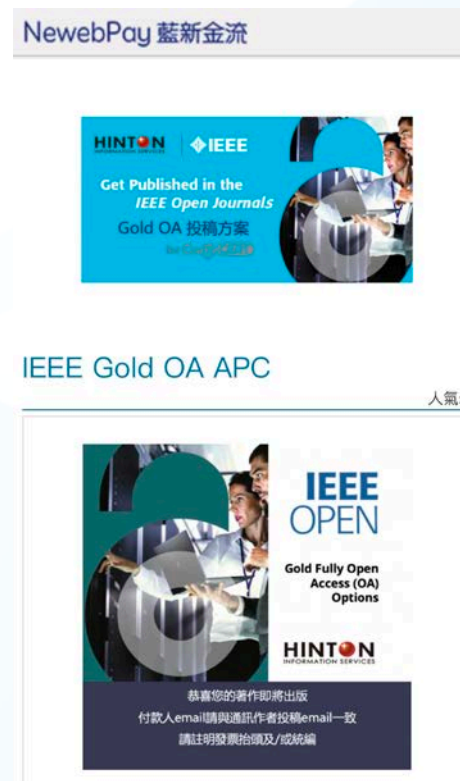
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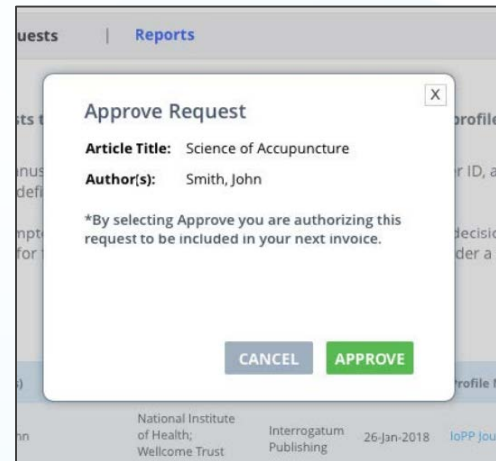
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